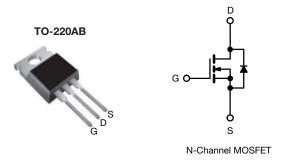
SiHP065N60E

Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.057			
Q _g max. (nC)	74				
Q _{gs} (nC)	19				
Q _{gd} (nC)	15				
Configuration	Single				

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qa
- Low effective capacitance (C_{o(er)})
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Load (Pb) free and helegen free	SiHP065N60E-BE3 ^a
Lead (Pb)-free and halogen-free	SiHP065N60E-GE3

Note

a. "-BE3" denotes alternate manufacturing location

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	600	v
Gate-source voltage	V _{GS}	± 30	v		
Continuous durin current (T 150 °C)	V at 10 V	$T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$	1	40	
Continuous drain current ($T_J = 150 \ ^\circ C$)	V _{GS} at 10 V	T _C = 100 °C	I _D	25	А
Pulsed drain current ^a			I _{DM}	116	
Linear derating factor				2.0	W/°C
Single pulse avalanche energy ^b			E _{AS}	226	mJ
Maximum power dissipation			P _D	250	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	
Drain-source voltage slope $T_J = 125 \text{ °C}$			-10.77-11	100	
Reverse diode dV/dt ^d			dV/dt	50	V/ns
Soldering recommendations (peak temperature) ^c	For	10 s		300	°C

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 4.0 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, dl/dt = 400 A/µs, starting T_J = 25 °C

S22-0949-Rev. E, 21-Nov-2022



HALOGEN

FREE



PARAMETER	SYMBOL	TYP. MAX.			UNIT		
Maximum junction-to-ambient	R _{thJA}	- 62			°C 111		
Maximum junction-to-case (drain)	R _{thJC}	-	0.5		°C/W		
SPECIFICATIONS (T _J = 25 °C,	unless otherwi	se noted)					
PARAMETER	SYMBOL	TEST CO	NDITIONS	MIN.	TYP.	MAX.	UNIT
Static	•	•				•	
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V,	I _D = 250 μA	600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference to 2	5 °C, I _D = 1 mA	-	0.72	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	$V_{DS} = V_{GS},$	I _D = 250 μA	3	-	5	V
Gate-source leakage	lass	V _{GS} =	± 20 V	-	-	± 100	nA
Gale-source leakage	I _{GSS}	V _{GS} =	± 30 V	-	-	± 1	μA
Zero gate voltage drain current		V _{DS} = 600 V	/, V _{GS} = 0 V	-	-	1	
zero gate voltage drain current	I _{DSS}	$V_{DS} = 480 \text{ V}, \text{ V}_{GS}$	V _{DS} = 480 V, V _{GS} = 0 V, T _J = 125 °C		-	10	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	V _{GS} = 10 V I _D = 16 A		0.057	0.065	Ω
Forward transconductance	g _{fs}	V _{DS} = 20 V	/, I _D = 16 A	-	12	-	S
Dynamic							
Input capacitance	C _{iss}	V _{GS}	= 0 V,	-	2700	-	
Output capacitance	C _{oss}	$V_{DS} = 100 V,$ f = 1 MHz		-	102	-	
Reverse transfer capacitance	C _{rss}			-	5	-	
Effective output capacitance, energy related ^a	C _{o(er)}	V OV to 4		-	93	-	pF
Effective output capacitance, time	0	$v_{\rm DS} = 0 \ v \ to \ 4$	80 V, V _{GS} = 0 V		500	1	

Effective output capacitance, time related ^b	C _{o(tr)}	20		-	593	-	
Total gate charge	Qg			-	49	74	
Gate-source charge	Q _{gs}	$V_{GS} = 10 V$	$I_D = 16 \text{ A}, V_{DS} = 480 \text{ V}$	-	19	-	nC
Gate-drain charge	Q _{gd}			-	15	-	
Turn-on delay time	t _{d(on)}			-	28	56	
Rise time	t _r	V _{DD} =	480 V, I _D = 16 A,	-	46	92	20
Turn-off delay time	t _{d(off)}	V _{GS} =	= 10 V, R_g = 9.1 Ω	-	54	108	ns
Fall time	t _f			-	13	26	
Gate input resistance	R _g	f = 1	MHz, open drain	0.3	0.7	1.4	Ω
Drain-Source Body Diode Characteristic	cs						
Continuous source-drain diode current	I _S	MOSFET sym showing the	bol	-	-	40	А
Pulsed diode forward current	I _{SM}	integral revers p - n junction		-	-	116	~
Diode forward voltage	V _{SD}	T _J = 25 °C	C, I _S = 16 A, V _{GS} = 0 V	-	-	1.2	V
Reverse recovery time	t _{rr}	.		-	382	764	ns
Reverse recovery charge	Q _{rr}	$I_{J} = 25$ dl/dt = 1	5 °C, I _F = I _S = 16 A, 00 A/µs, V _B = 400 V	-	7.1	14.2	μC
Reverse recovery current	I _{RRM}	$d_{1}/dt = 100 \text{ Av} \mu \text{s}, V_{\text{R}} = 400 \text{ V}$		-	34	-	А

Notes

Effective output capacitance, time

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

b. Coss(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 % to 80 % VDSS





TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

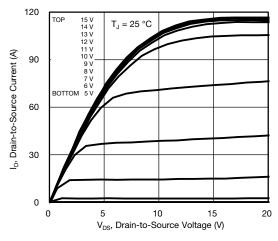
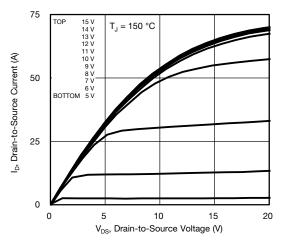


Fig. 1 - Typical Output Characteristics





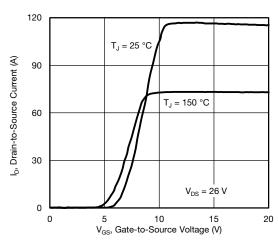


Fig. 3 - Typical Transfer Characteristics

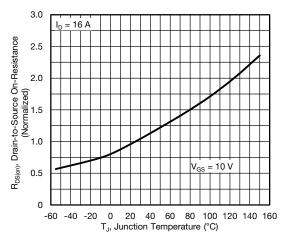


Fig. 4 - Normalized On-Resistance vs. Temperature

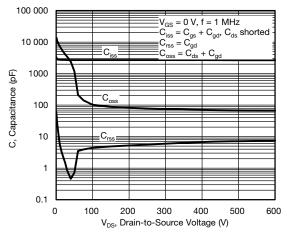


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

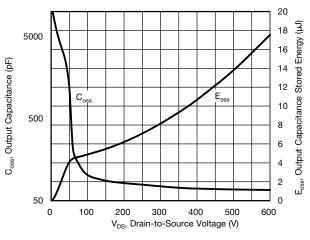


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

S22-0949-Rev. E, 21-Nov-2022

3 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 91938

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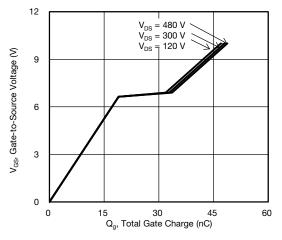


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

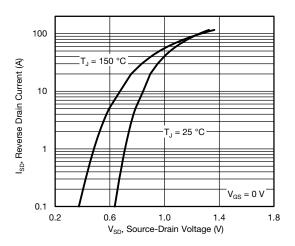


Fig. 8 - Typical Source-Drain Diode Forward Voltage

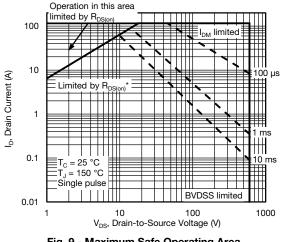


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

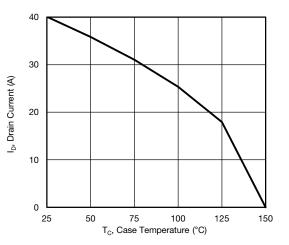


Fig. 10 - Maximum Drain Current vs. Case Temperature

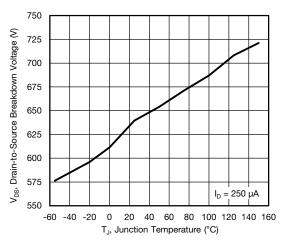
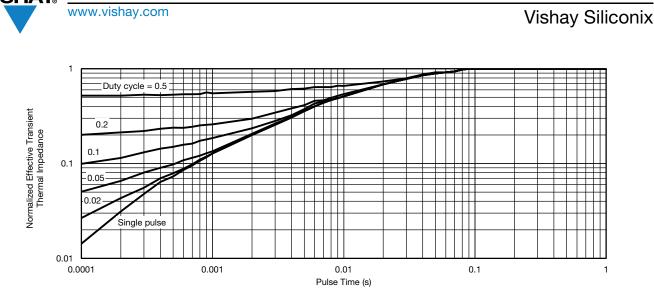


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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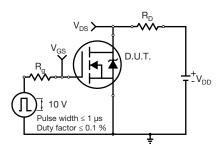


Fig. 13 - Switching Time Test Circuit

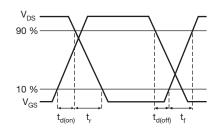


Fig. 14 - Switching Time Waveforms

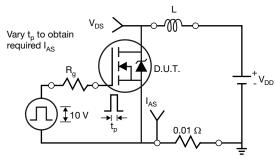


Fig. 15 - Unclamped Inductive Test Circuit

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Fig. 16 - Unclamped Inductive Waveforms

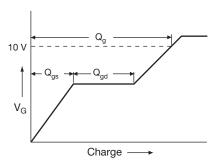


Fig. 17 - Basic Gate Charge Waveform

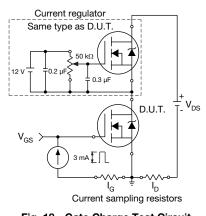
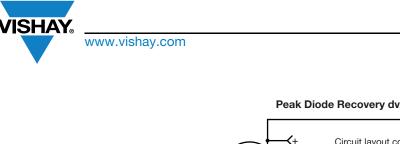


Fig. 18 - Gate Charge Test Circuit

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Peak Diode Recovery dv/dt Test Circuit

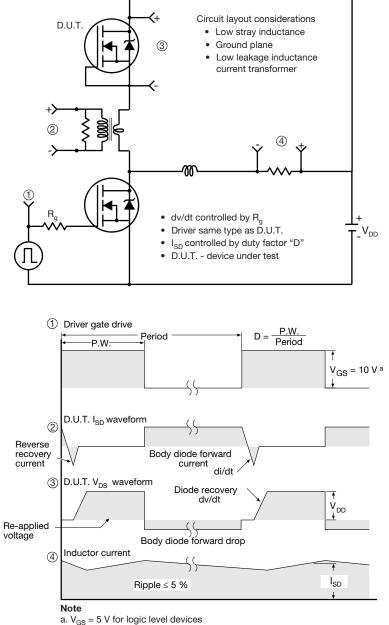
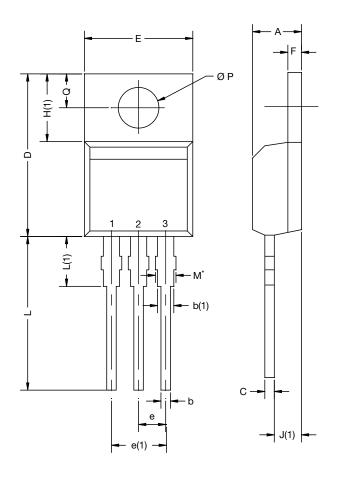


Fig. 19 - For N-Channel

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TO-220-1



DIM.	MILLIN	METERS	INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØP	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

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